



Package: SOT-86

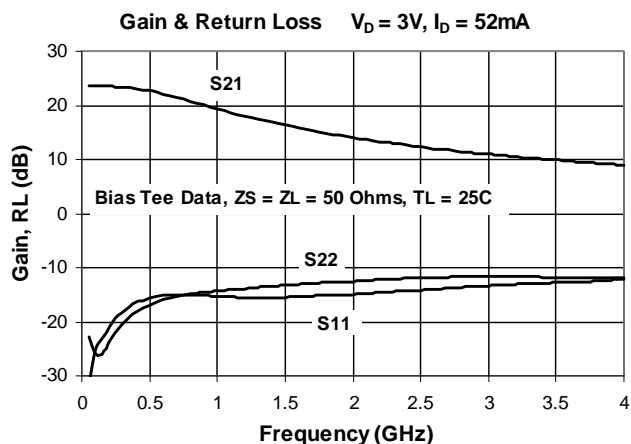


Product Description

RFMD's SGC4486Z is a high performance SiGe HBT MMIC amplifier utilizing a Darlington configuration with a patented active bias network. The active bias network provides stable current over temperature and process Beta variations. Designed to run directly from a 3V supply, the SGC4486Z does not require a dropping resistor as compared to typical Darlington amplifiers. The SGC4486Z is designed for high linearity 3V gain block applications that require small size and minimal external components. It is internally matched to 50Ω.

Optimum Technology Matching® Applied

- ☐ GaAs HBT
- ☐ GaAs MESFET
- ☐ InGaP HBT
- ☐ SiGe BiCMOS
- ☐ Si BiCMOS
- ☒ SiGe HBT
- ☐ GaAs pHEMT
- ☐ Si CMOS
- ☐ Si BJT
- ☐ GaN HEMT
- ☐ RF MEMS



Features

- Single Fixed 3V Supply
- No Dropping Resistor Required
- Patented Self-Bias Circuitry
- $P_{1dB} = 12.7 \text{ dBm}$ at 1950MHz
- $OIP_3 = 27.5 \text{ dBm}$ at 1950MHz
- Robust 1000V ESD, Class 1C HBM

Applications

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS, WCDMA
- IF Amplifier
- Wireless Data, Satellite

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Small Signal Gain	19.0	20.5	22.0	dB	850MHz
	13.0	14.5	16.0	dB	1950MHz
		12.3		dB	2400MHz
Output Power at 1dB Compression		13.8		dBm	850MHz
	11.7	12.7		dBm	1950MHz
		12.4		dBm	2400MHz
Output Third Order Intercept Point		29.0		dBm	850MHz
	25.5	27.5		dBm	1950MHz
		26.5		dBm	2400MHz
Input Return Loss	10.5	14.5		dB	1950MHz
Output Return Loss	7.5	11.5		dB	1950MHz
Noise Figure		3.4	4.4	dB	1930MHz
Thermal Resistance		145		$^\circ C/W$	junction - lead
Device Operating Voltage		3.0		V	
Device Operating Current	46.0	52.0	58.0	mA	

Test Conditions: $V_D = 3V, I_D = 52mA$ Typ., OIP_3 Tone Spacing = 1MHz, P_{OUT} per tone = -5dBm, $T_L = 25^\circ C, Z_S = Z_L = 50\Omega$, Bias Tee Data

Absolute Maximum Ratings

Parameter	Rating	Unit
Device Current (I_{CE})	110	mA
Device Voltage (V_{CE})	4	V
RF Input Power* (See Note)	12	dBm
Junction Temp (T_J)	+150	°C
Operating Temp Range (T_L)	-40 to +85	°C
Storage Temp	+150	°C
ESD Rating - Human Body Model (HBM)	Class 1C	
Moisture Sensitivity Level	MSL 1	

*Note: Load condition $Z_L = 50\Omega$

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

Bias Conditions should also satisfy the following expression:

$$I_D V_D < (T_J - T_L) / R_{TH, J-L} \text{ and } T_L = T_{LEAD}$$



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

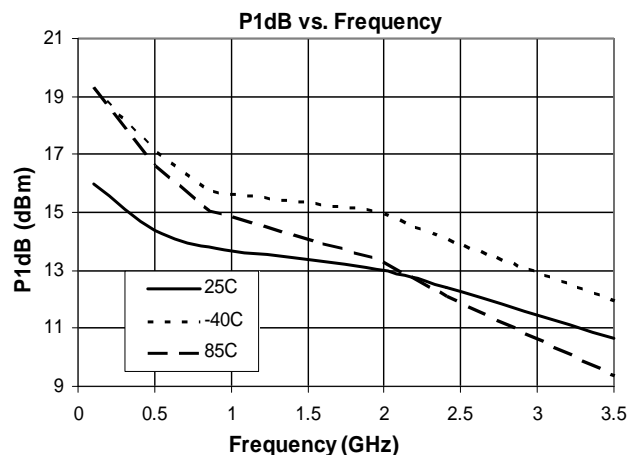
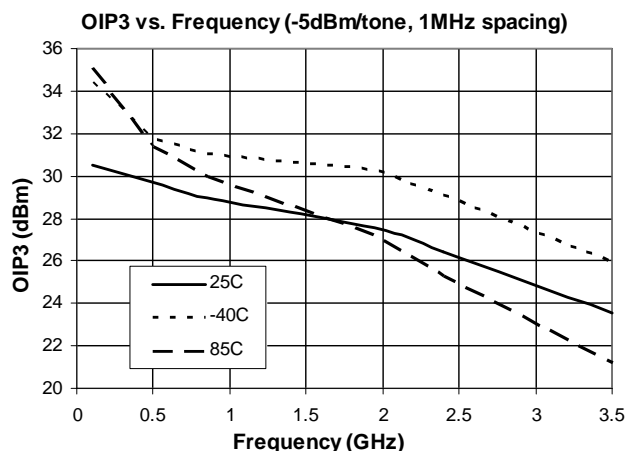
RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

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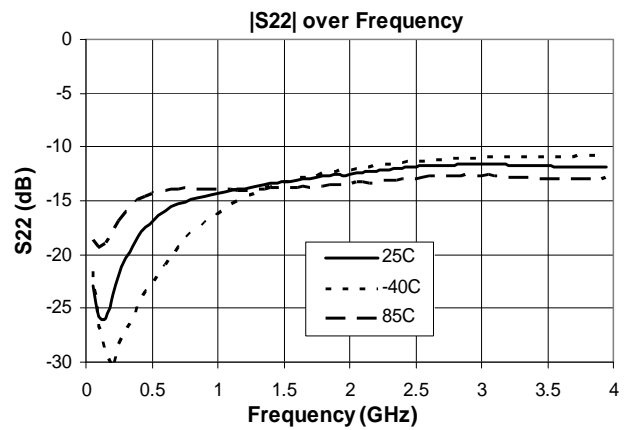
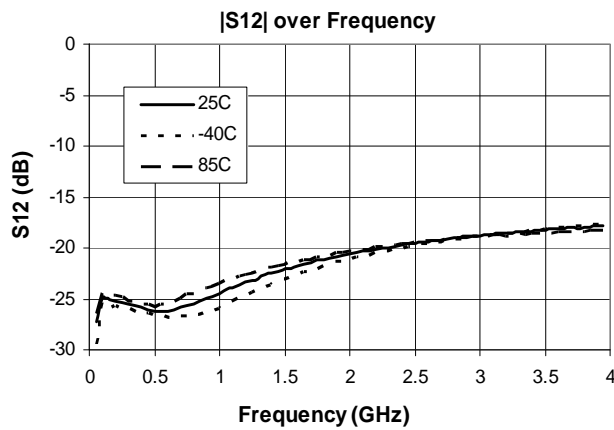
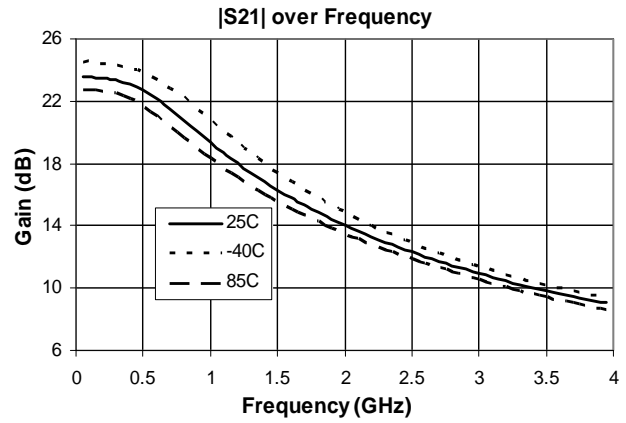
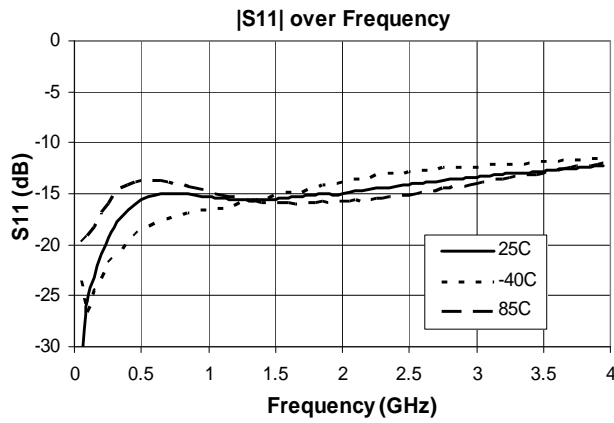
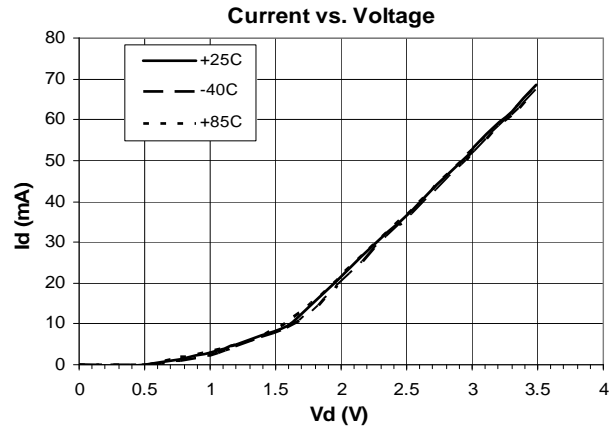
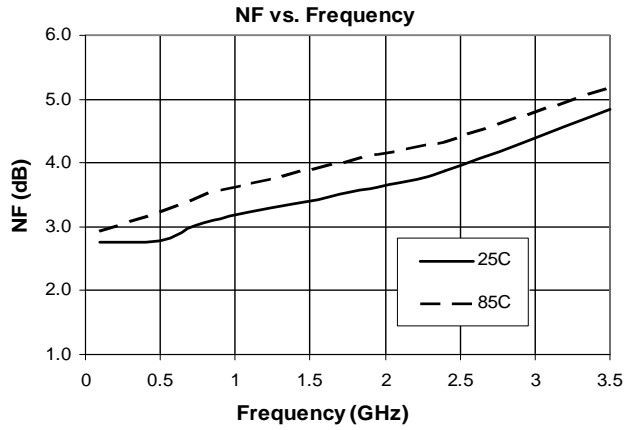
Typical RF Performance with Application Circuit at Key Operating Frequencies (Bias Tee)

Parameter	Unit	100 MHz	500 MHz	850 MHz	1950 MHz	2400 MHz	3500 MHz
Small Signal Gain (G)	dB	23.5	22.5	20.5	14.5	12.3	9.5
Output Third Order Intercept Point (OIP_3)	dBm	30.5	29.5	29.0	27.5	26.5	23.5
Output Power at 1dB Compression (P_{1dB})	dBm	16.1	14.4	13.8	12.7	12.4	10.6
Input Return Loss (IRL)	dB	24.0	15.5	16.5	14.5	14.5	13.0
Output Return Loss (ORL)	dB	25.0	17.0	16.5	11.5	12.0	11.0
Reverse Isolation (S_{12})	dB	25.0	26.0	25.0	20.5	19.0	17.5
Noise Figure (NF)	dB	2.8	2.8	3.1	3.4	3.9	4.8

Test Conditions: $V_D = 3V$, $I_D = 52mA$ Typ. OIP_3 Tone Spacing = 1MHz, P_{OUT} per tone = -5dBm
 $T_L = 25^\circ C$, $Z_S = Z_L = 50\Omega$

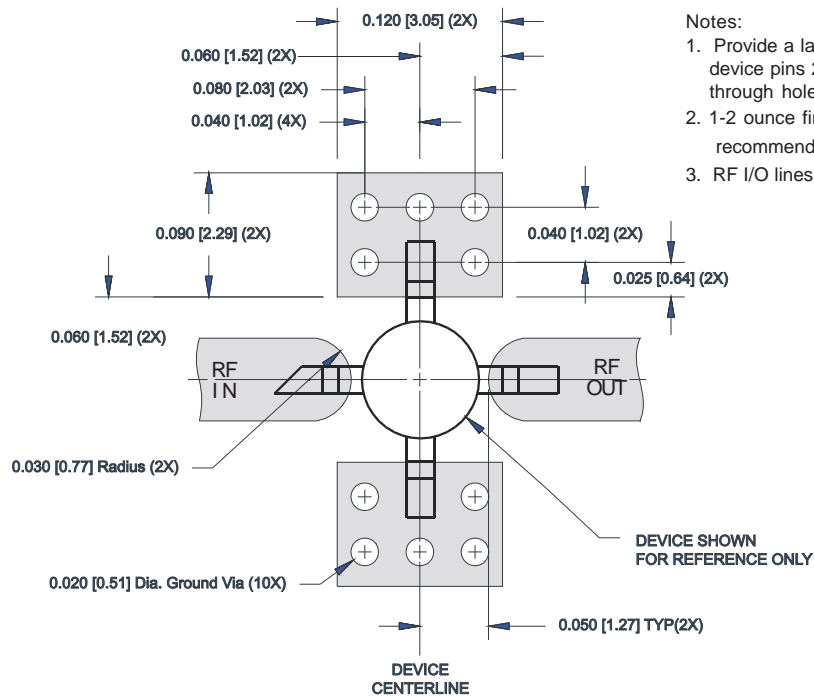
Typical Performance with Bias Tee, $V_D = 3V$, $I_D = 52mA$ 

Typical Performance with Bias Tee, $V_D = 3V$, $I_D = 52mA$



86 PCB Pad Layout

Dimensions in inches [millimeters]

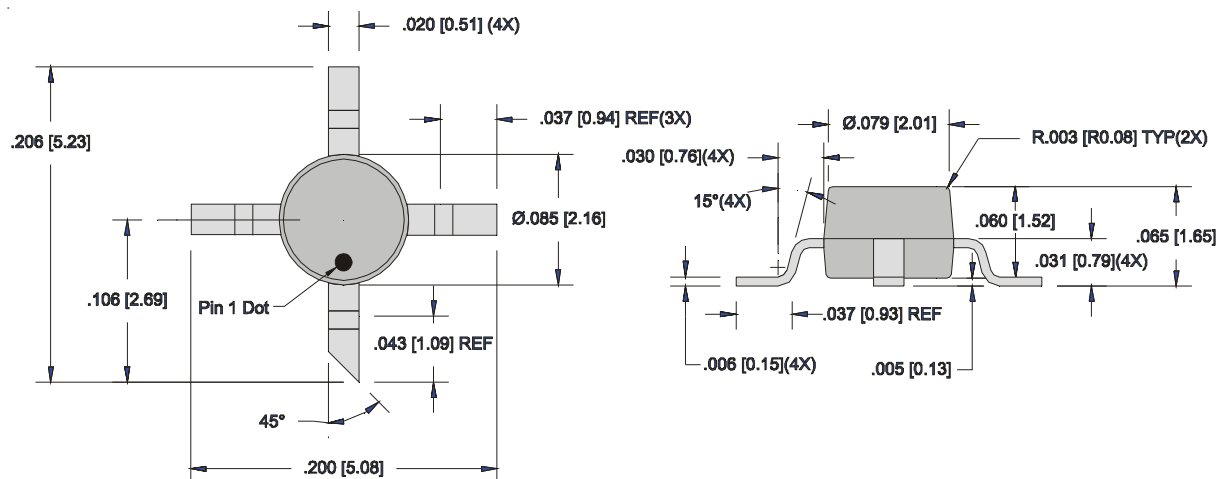


Notes:

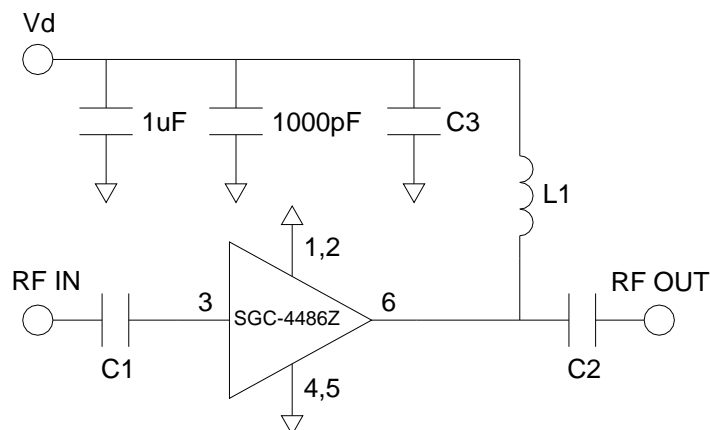
1. Provide a large ground pad area under device pins 2 and 4 with several plated-through holes placed as shown.
2. 1-2 ounce finished copper thickness is recommended.
3. RF I/O lines are 50Ω

86 Nominal Package Drawing

Dimensions in inches (millimeters)

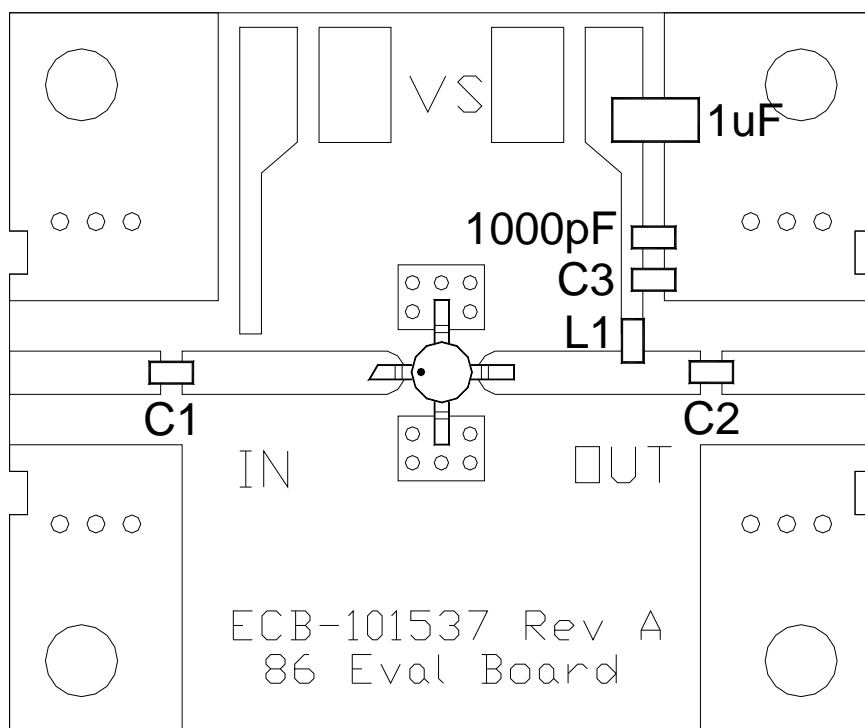
Refer to drawing posted at www.rfmd.com for tolerances.

Application Schematic

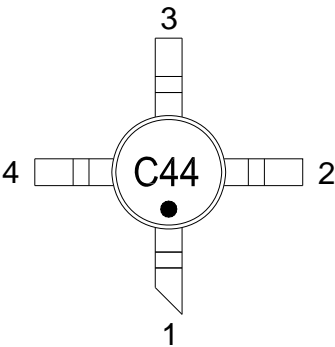


Application Circuit Element Values		
Reference Designator	100-2000MHz	2000-4000MHz
C1	1000pF	2.7pF
C2	100pF	6.8pF
C3	100pF	6.8pF
L1	120nH	39nH

Evaluation Board Layout



Part Identification



Ordering Information

Ordering Code	Description
SGC4486Z	13" Reel with 3000 pieces
SGC4486ZSQ	Sample bag with 25 pieces
SGC4486ZSR	7" Reel with 100 pieces
SGC4486ZPCK1	100MHz to 2000MHz PCBA with 5-piece sample bag
SGC4486ZPCK2	2000MHz to 4000MHz PCBA with 5-piece sample bag